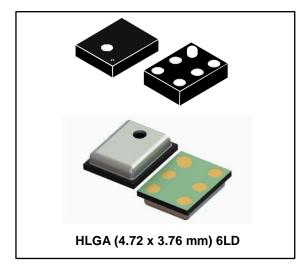


MP45DT02

MEMS audio sensor omnidirectional digital microphone

Datasheet - production data



Features

- Single supply voltage
- Low power consumption
- 120 dBSPL acoustic overload point
- Omnidirectional sensitivity
- PDM single-bit output with option for stereo configuration
- HLGA package (SMD-compliant) plastic or metal
- ECOPACK[®], RoHS, and "Green" compliant

Applications

- Mobile terminals
- Laptop and notebook computers
- Portable media players
- VolP
- Speech recognition
- A/V eLearning devices
- Gaming and virtual reality input devices
- Digital still and video cameras
- Antitheft systems

Description

The MP45DT02 is a compact, low-power, topport, omnidirectional, digital MEMS microphone. The MP45DT02 is built with a sensing element and an IC interface with stereo capability.

The sensing element, capable of detecting acoustic waves, is manufactured using a specialized silicon micromachining process to produce audio sensors.

The IC interface is manufactured using a CMOS process that allows designing a dedicated circuit able to provide a digital signal externally in PDM format.

The MP45DT02 has an acoustic overload point of 120 dBSPL with a best on the market 61 dB signal-to-noise ratio and -26 dB sensitivity.

The MP45DT02 is available in an SMD-compliant metal (M) or plastic package and is guaranteed to operate over an extended temperature range from -30 $^{\circ}$ C to +85 $^{\circ}$ C.

The MP45DT02's digital output and package size (1.25 mm thick) make this device the best solution for laptop and portable computing applications.

Table 1: Device summary

Order code	Temp. range [°C]	Package	Packing		
MP45DT02	-30 to +85	HLGA 4.72x3.76 6LD	Tray		
MP45DT02TR	-30 to +85	HLGA 4.72x3.76 6LD	Tape and reel		
MP45DT02TR-M	-30 to +85	HLGA 4.72x3.76 6LD	Tape and reel		

January 2016

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This is information on a product in full production.

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Pin description 1

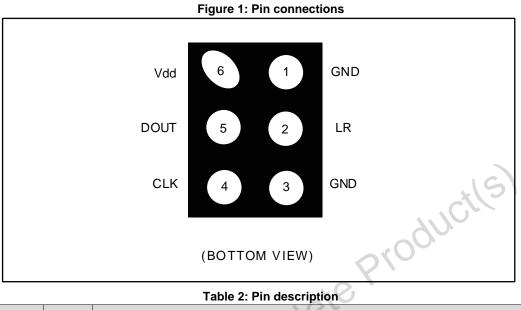


	Table	2: Pin	description
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	Pin n°	Pin name	Function
	1	GND	0 V supply
	2	LR	Left/right channel selection; MIC1 LR is connected to GND or Vdd and MIC2 LR is connected to Vdd or GND (see <i>Figure 5: "MP45DT02 electrical connections for stereo configuration"</i>)
	3	GND	0 V supply
	4	CLK	Synchronization input clock
	5	DOUT	Left/right PDM data output
	6	Vdd	Power supply
Obsolf	ste		



2 Acoustic and electrical specifications

2.1 Acoustic and electrical characteristics

The values listed in the table below are specified for Vdd = 1.8 V, Clock = 2.4 MHz, T = 25 °C, unless otherwise noted.

Symbol	Parameter	Test condition	Min.	Тур. ⁽¹⁾	Max.	Unit
Vdd	Supply voltage		1.64	1.8	3.6	V
Idd	Current consumption in normal mode	No load on data line		0.65		mA
IddPdn	Current consumption in power-down mode ⁽²⁾			20		μA
Scc	Short-circuit current		1		10	mA
AOP	Acoustic overload point			120		dBSPL
So	Sensitivity		-29	-26	-23	dBFS
SNR	Signal-to-noise ratio	A-weighted @1 kHz, 1 Pa	1ete	61		dB
PSR	Power supply rejection	Guaranteed by design ⁽³⁾)``	-70		dBFS
Clock	Input clock frequency (4)	()	1	2.4	3.25	MHz
TWK	Wake-up time ⁽⁵⁾	Guaranteed by design			10	ms
Тор	Operating temperature range		-30		+85	°C
V _{IOL}	Low level logic input/output voltage	I _{out} = 1 mA	-0.3		0.35xVdd	V
V _{IOH}	High level logic input/output voltage	I _{out} = 1 mA	0.65xVdd		Vdd+0.3	V

Table 3: Acoustic and electrical characteristics

Notes:

⁽¹⁾Typical specifications are not guaranteed.

⁽²⁾Input clock in static mode.

⁽³⁾Test signal: 217 Hz square wave, 100 mVpp on Vdd pin.

⁽⁴⁾Duty cycle: min = 40% max = 60%.

⁽⁵⁾Time from the first clock edge to valid output data.

Table 4: Distortion specifications

Parameter	Test condition	Value
Distortion	100 dBSPL (50 Hz - 4 kHz)	< 1% THD + N
Distortion	115 dBSPL (1 kHz)	< 5% THD + N

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Timing characteristics 2.2

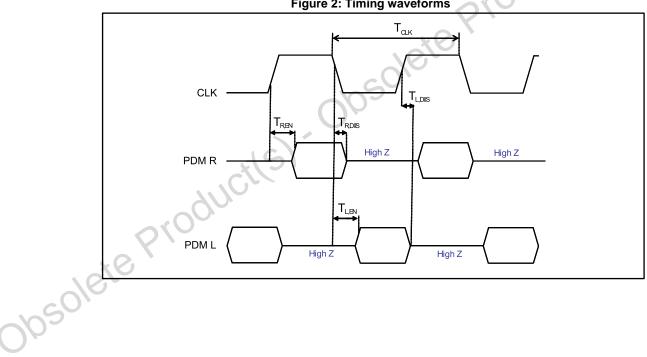
Table 5: Timing characteristics

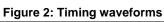
Parameter	Description	Min	Max	Unit
f _{CLK}	Clock frequency for normal mode	1	3.25	MHz
f _{PD}	Clock frequency for power-down mode		0.23	MHz
T _{CLK}	Clock period for normal mode	308	1000	ns
T _{R,EN}	Data enabled on DATA line, L/R pin = 1	30 ⁽¹⁾		ns
T _{R,DIS}	Data disabled on DATA line, L/R pin = 1		16 ⁽¹⁾⁽²⁾	ns
T _{L,EN}	Data enabled on DATA line, L/R pin = 0	30 ⁽¹⁾		ns
T _{L,DIS}	Data disabled on DATA line, L/R pin = 0		16 ⁽¹⁾⁽²⁾	ns

Notes:

⁽¹⁾From design simulations

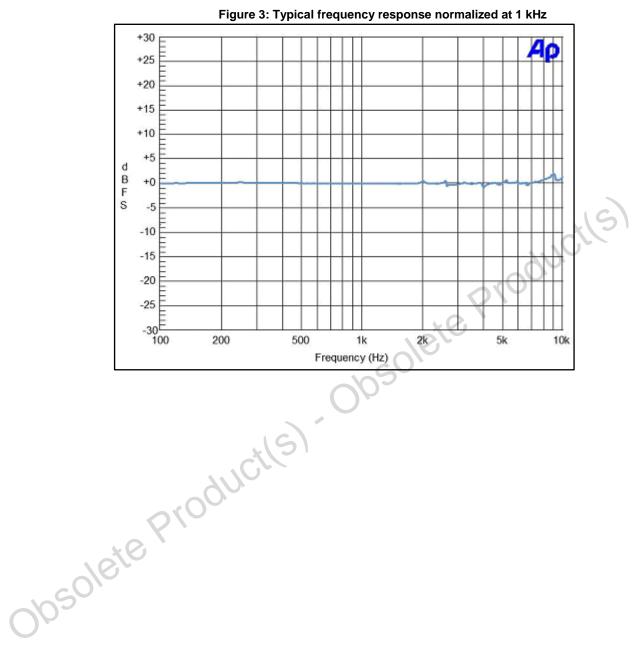
 $^{(2)}$ In order to measure the disable time, a 1 k Ω pull-down resistor must be added to the DOUT pin.







2.3 Frequency response



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3 Sensing element

The sensing element shall mean the acoustic sensor consisting of a conductive movable plate and a fixed plate placed in a tiny silicon chip. This sensor transduces the sound pressure into the changes of coupled capacity between those two plates.

Omron Corporation supplies this element for STMicroelectronics.

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Absolute maximum ratings 4

Stresses above those listed as "absolute maximum ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device under these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

Symbol	Ratings	Maximum value	Unit
Vdd	Supply voltage	-0.3 to 6	V
Vin	Input voltage on any control pin	-0.3 to Vdd +0.3	V
T _{STG}	Storage temperature range	-40 to +125	°C
ESD	Electrostatic discharge protection	2 (HBM)	kV

Table 6:	Absolute	maximum	ratings
	Absolute	maximum	raungs



This device is sensitive to mechanical shock, improper handling can cause permanent damage to the part.

charge (i obsolete produci(s) This device is sensitive to electrostatic discharge (ESD), improper handling can



5 Functionality

5.1 L/R channel selection

The L/R digital pad lets the user select the DOUT signal pattern as explained in *Table 7: "L/R channel selection"*. The L/R pin must be connected to Vdd or GND.

Table	7:	I/R	channel	selection
IUNIC		L / I \	Channel	3010011011

	L/R	CLK low	CLK high		
	GND	Data valid	High impedence		
	Vdd	High impedence	Data valid		
005019	stepro	obsolitation of the second sec	High impedence Data valid		



6 Application recommendations

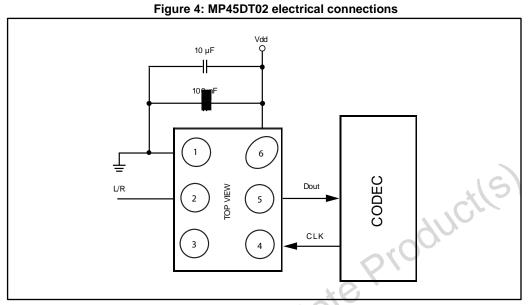
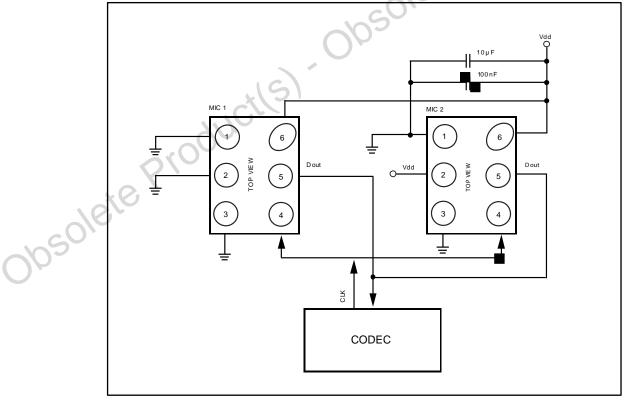


Figure 5: MP45DT02 electrical connections for stereo configuration



Power supply decoupling capacitors (100 nF ceramic, 10 μF ceramic) should be placed as near as possible to pin 6 of the device (common design practice).

The L/R pin must be connected to Vdd or GND (refer to Table 7: "L/R channel selection").

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7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

7.1 Soldering information

The HLGA (4.72 x 3.76 x 1.25) mm package is also compliant with the RoHS and "Green" standards and is qualified for soldering heat resistance according to JEDEC J-STD-020.

Landing pattern and soldering recommendations are available at www.st.com.

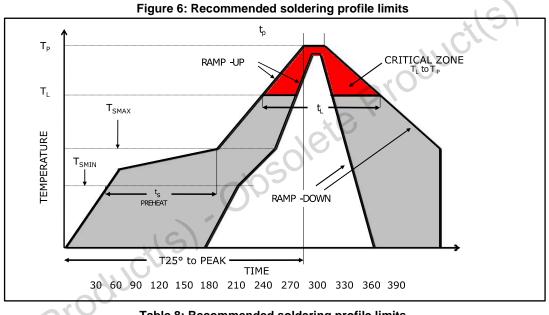


Table 8: Recommended soldering profile limits					
Description	Parameter	Pb free			
Average ramp rate	T _L to T _P	3 °C/sec max			
Preheat Minimum temperature Maximum temperature Time (T _{SMIN} to T _{SMAX})	T _{SMIN} T _{SMAX} t _S	150 °C 200 °C 60 sec to 120 sec			
Ramp-up rate	T_{SMAX} to T_{L}				
Time maintained above liquidus temperature Liquidus temperature	t∟ T∟	60 sec to 150 sec 217 °C			
Peak temperature	T _P	260 °C max			
Time within 5 °C of actual peak temperature		20 sec to 40 sec			
Ramp-down rate		6 °C/sec max			
Time 25 °C (t25 °C) to peak temperature		8 minutes max			



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7.2 HLGA (4.72 x 3.76 mm) 6L (plastic) package information

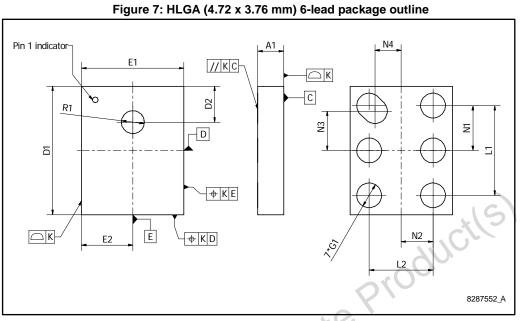
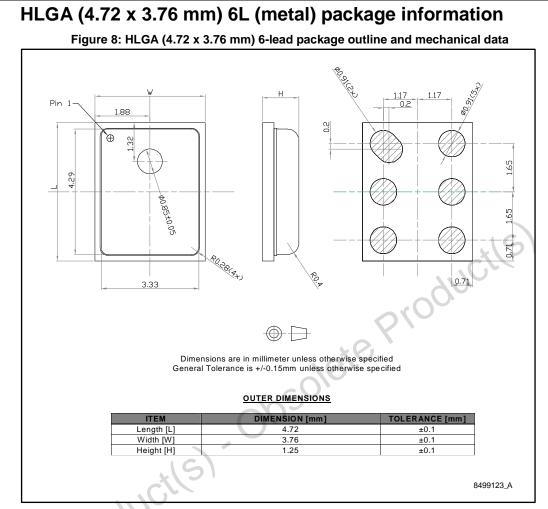


Table 9: HLGA (4.72 x 3.76 mm) 6-lead package	maahaniaal data
Table 9. FILGA (4.72 X 3.70 mm) o-lead backage	mechanical data

	Symbol	mm.		
	Symbol	Min.	Б Тур.	Max.
	A1	1.125	1.250	1.375
	D1	4.670	4.720	4.770
	D2	15	1.320	
	R1	0.750	0.840	0.930
E1	E1	3.710	3.760	3.810
E2			1.880	
	L1	3.200	3.300	3.400
× (L2	2.250	2.350	2.450
obsolet	N1	1.550	1.650	1.750
cO'	N2	1.075	1.175	1.275
~05	N3	1.350	1.450	1.550
U Y	N4	0.865	0.965	1.065
	G1	0.810	0.910	1.010
	К		0.050	



7.3



Note: The MEMS microphone metal cap can exhibit some level of variation in color when the device is subjected to a thermal process.



8 Revision history

Table 10: Document revision history

	Date	Revision	Changes		
	28-Mar-2011	1	Initial release		
	21-Oct-2011	2	Added max. peak temperature T _P to Added min. and max. sensitivity So to <i>Table 3: "Acoustic and</i> <i>electrical characteristics"</i>		
	01-Mar-2012	3	Document status promoted from preliminary to production data Updated SNR to 61 dB ("Description" and Table 3: "Acoustic and electrical characteristics")		
	07-May-2012	4	Added V _{IOL} , V _{IOH} to Table 3: "Acoustic and electrical characteristics"		
	05-Jul-2012	5	Added Section 4: "Sensing element"		
	21-Mar-2014	6	Added new package "Figure 8: "HLGA (4.72 x 3.76 mm) 6-lead package outline and mechanical data"		
	17-Jun-2014	7	Updated "Figure 3: Typical frequency response normalized at 1 kHz"		
	26-Jan-2016	8	Added footnote concerning disable time to <i>Table 5: "Timing characteristics"</i>		
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MP45DT02

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